The documentation and process conversion measures necessary to comply with this revision shall be completed by 25 June 1995

INCH-POUND

MIL-S-19500/5018 25 March 1995 SUPERSEDING HIL-S-19500/501A 1 April 1982

MILITARY SPECIFICATION

SEMICONDUCTOR DEVICE, DARLINGTON TRANSISTOR, PNP, SILICON, POWER TYPE 2N6051, 2N6052 JAN, JANTX, AND JANTXV

This specification is approved for use by all Departments and Agencies of the Department of Defense.

- 1. SCOPE
- 1.1 <u>Scope</u>. This specification covers the detail requirements for PNP, Darlington, silicon, power transistors. Three levels of product assurance are provided for each device type as specified in MIL-S-19500.
 - 1.2 Physical dimensions. See figure 1 (TO-3).
 - 1.3 Maximum ratings.

	P _T <u>1</u> /		v _{сво}	V _{CEO}	V _{EBO}	1 _C	1 _B	Top and TSTG
	T _C = +25°C	T _C = +100°C						
2n6051 2n6052	y 150 150	¥ 75 75	<u>V dc</u> 80 100	<u>V dc</u> 80 100	<u>V dc</u> 5 5	A dc 12 12	A dc 0.2 0.2	<u>°c</u> -55 to +175 -55 to +175

- 1/ Derate linearly at 1.00 W/°C above $T_C > +25$ °C.
- 1.4 Primary electrical characteristics.

	hFE2 1/	h _{FE3} 1/ V _{CE} = 3 V dc	h _{fe} V _{CE} = 3 V dc	hfe	C _{obo} 100 kHz ≤ f ≥ 1 MHz	Pulse response	
	h _{FE2} 1/ V _{CE} = 3 V dc I _C = 6 A dc	I _C = 12 A dc	I _C = 5 A dc f = 1 kHz	hfe VCE = 3 V dc IC = 5 A dc f = 1 MHz	V _{CB} = 10 V dc I _E = 0	ton	^t off
Min	1,000	150	1,000	10	pF	ħε	Пa
Max	18,000	130	1,550	250	300	2	10

	$I_{C} = 12 \text{ A dc}$ $I_{B} = 120 \text{ mA dc}$ $\underline{1}/$	$V_{CE(sat)1}$ $I_{C} = 12 \text{ A dc}$ $I_{B} = 120 \text{ mA dc}$	$V_{CE(sat)2}$ $I_C = 6 \text{ A dc}$ $I_B = 24 \text{ mA dc}$ $1/$	R ⊝uc
Min	V dc	V dc	<u>V dc</u>	°C/W
Max	4.0	3.0	2.0	1.00

1/ Pulsed, see 4.5.1

Beneficial comments (recommendations, additions, deletions) and any pertinent data which may be of use in improving this document should be addressed to: NASA/Parts Project Office (NPPO) NASA Goddard Space Flight Center, Code 310.A, Greenbelt, MD 20771-3917 by using the Standardization Document Improvement Proposal (DD Form 1426) appearing at the end of this document or by letter.

AMSC N/A <u>DISTRIBUTION STATEMENT A.</u> Approved for public release; distribution is unlimited.

FSC 5961

- 2. APPLICABLE DOCUMENTS
- 2.1 Government documents.
- 2.1.1 <u>Specifications, standards, and handbooks</u>. The following specifications, standards, and handbooks form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DODISS) and supplement thereto, cited in the solicitation (see 6.2).

SPECIFICATION

MILITARY

MIL-S-19500 - Semiconductor Devices, General Specification for.

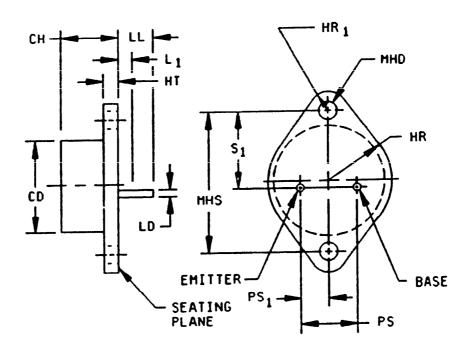
STANDARD

MILITARY

MIL-STD-750 - Test Methods for Semiconductor Devices.

(Unless otherwise indicated, copies of federal and military specifications, standards, and handbooks are available from the Defense Printing Services Detachment Office, Building 4D (Customer Service), 700 Robbins Avenue, Philadelphia, PA 19111-5094).

- 2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this document and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.
 - 3. REQUIREMENTS
- 3.1 <u>Associated detail specification</u>. The individual item requirements shall be in accordance with MIL-S-19500, and as specified herein.
- 3.2 <u>Abbreviations, symbols, and definitions</u>. Abbreviations, symbols, and definitions used herein shall be as specified in MIL-S-19500.
- 3.3 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-S-19500 and on figure 1 herein. No aluminum case shall be permitted.
- 3.3.1 <u>Lead finish</u>. Lead finish shall be solderable in accordance with MIL-S-19500. Where a choice of lead finish is desired, it shall be specified in the acquisition document (see 6.2).
 - 3.4 Marking. Marking shall be in accordance with MIL-S-19500.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection shall be in accordance with MIL-S-19500, and as specified herein.
 - 4.2 Qualification inspection. Qualification inspection shall be in accordance with MIL-S-19500.



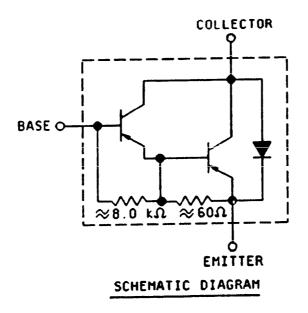


FIGURE 1. Physical dimensions and schematic circuit.

Ltr	Inch	es	Millim	eters	Hotes
<u></u>	Min	Max	Min	Max	
СН	.250	. 328	6.35	8.33	
LD	.038	.043	0.97	1.09	5,9,11
CD		.875		22.23	3,11
PS	. 420	.440	10.67	11.18	4, 10
PS1	. 205	. 225	5.21	5.72	4,5,10
нт	.060	.135	1.52	3.43	
LL	.312	.500	7.92	12.70	5
L1		.050		1.27	5, 9
MHD	.151	.161	3.84	4.09	7,11
MHS	1,177	1.197	29.90	30.40	
HR	. 495	. 525	12.57	13.34	
HR ₁	. 131	.188	3.33	4.78	6
sı	.655	.675	16.64	17.15	4

NOTES:

- 1. Dimensions are in inches.
- 2. Metric equivalents are given for general information only.
- 3. Body contour is optional within zone defined by CD.
- 4. These dimensions shall be measured at points .050 inch (1.27 mm) to .055 $\,$ inch (1.40 mm) below the seating plane. When gauge is not used, measurement shall be made at seating plane.
- 5. Both terminals.
- 6. At both ends.
- 7. Two holes.
- The collector shall be electrically connected to the case.
 LD applies between L₁ and LL. Diameter is uncontrolled in LD applies between L_1 and LL. Diameter is uncontrolled in L_1 .
- 10. The seating plane of the header shall be flat within .001 inch (0.03 mm), concave to .004 inch (0.10 mm), convex inside a .930 inch (23.62 mm) diameter circle on the center of the header, and flat within .001 inch, (0.03 mm) concave to .006 inch (0.15 mm), convex overall.
- 11. In accordance with ANSI Y14.5M, diameters are equivalent to ϕx symbology.

FIGURE 1. Physical dimensions and schematic circuit - Continued.

[00/11/1

4.3 <u>Screening (JANTX and JANTXV only)</u>. Screening shall be in accordance with table II of MIL-S-19500, and as specified herein. The following measurements shall be made in accordance with table I herein. Devices that exceed the limits of table I herein shall not be acceptable.

Screen (see table II of	Measur eme nts				
MIL-S-19500)	JANTX and JANTXV tevels				
9	I _{CEX1}				
11	I_{CEX1} , h_{FE2} ; $\Delta I_{CEX1} = 100$ percent of initial value or $100 \mu A$ dc; whichever is greater.				
12	See 4.3.1				
13	Subgroup 2 of table I herein; ΔI_{CEX1} = 100 percent of initial value or 100 μ A dc, whichever is greater. Δh_{FE2} = ± 40 percent of initial value.				

4.3.1 Power burn-in conditions. Power burn-in conditions are as follows:

 $T_J = +162.5$ °C ± 12.5 °C; $V_{CE} \ge 10$ V dc, $T_A \le +100$ °C.

NOTE: No heat sink or forced air cooling on the devices shall be permitted.

- 4.4 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with MIL-S-19500.
- 4.4.1 <u>Group A inspection</u>. Group A inspection shall be conducted in accordance with MIL-S-19500, and table I herein. Electrical measurements (end-points) and delta requirements shall be in accordance with the applicable steps of table II herein.
- 4.4.2 <u>Group B inspection</u>. Group B inspection shall be conducted in accordance with the conditions specified for subgroup testing in table IVb (JAN, JANTX and JANTXV) of MIL-S-19500. Electrical measurements (end-points) and delta requirements shall be in accordance with the applicable steps of table II herein.
 - 4.4.2.1 Group B inspection, table 17b (JAN, JANTX and JANTXY) of MIL-S-19500.

Subgroup	Method	Conditions
в3	1037	$V_{CB} \ge 10$ V dc; ΔT_J = between cycles $\ge +100^{\circ}$ C. $t_{OB} = t_{Off} = 3$ minutes for 2,000 cycles. No heat sink or forced-air cooling on the devices shall be permitted.
85	3151	R _{OJC} = 1°C/W (maximum).

- 4.4.3 <u>Group C inspection</u>. Group C inspection shall be conducted in accordance with the conditions specified for subgroup testing in table V of MIL-8-19500. Electrical measurements (end-points) and delta requirements shall be in accordance with the applicable steps of table II herein.
 - 4.4.3.1. Group C inspection, table V of MIL-S-19500.

Subgroup	Method	Conditions
C6	1037	$V_{CB} \ge 10$ V dc; ΔT_J between cycles $\ge +100^{\circ}$ C. $t_{on} = t_{off} = 3$ minutes for 6,000 cycles. No heat sink or forced-air cooling on device shall be permitted.

TABLE I. Group A inspection.

	MIL-STD-750			Limit		1 11-40
Inspection 1/	Method Conditions		Symbol	Min	Max	Unit
Subgroup 1						
Visual and mechanical examination	2071	1		1	<u> </u>	i
Subgroup 2	İ		į	į	İ	j !
 Breakdown voltage, collector - emitter	3011	Bias condition D; I _C = 100 mA dc; pulsed (see 4.5.1)	V(BR)CEO		 	
206051 206052	!			80 100		V dc V dc
 Collector - emitter cutoff current 2N6O51	3041	 Bias condition A; V _{BE} = 1.5 V dc; V _{CE} = 80 V dc	I _{CEX1}		0.5	mAdc
2N6052		VCE = 80 V dc			•	mA dc
 Collector - emitter cutoff current	3041	Bias condition D	ICEO			
2n6051 2n6052]	V _{CE} = 40 V dc V _{CE} = 50 V dc			:	mAdc mAdc
 Emitter - base cutoff current	3061	Bias condition D; V _{EB} = 5 V dc	IEBO		2.0	mA dc
Base - emitter voltage (nonsaturated)	3066	Test condition B; V _{CE} = 3 V dc; I _C = 6 A dc	VBE		2.8	V dc
Base - emitter voltage (saturated)	İ	Test condition A; $I_C = 12 \text{ A dc};$ $I_B = 120 \text{ mA dc};$ pulsed (see 4.5.1)	VBE(sat)		4.0	V dc
Collector - emitter voltage (saturated)	1 1	I_C = 12 A dc; I_B = 120 mA dc; pulsed (see 4.5.1)	V _{CE} (sat)1		3.0	V dc
Collector - emitter voltage (saturated)	(I _C = 6 A dc; I _B = 24 mA dc; pulsed (see 4.5.1)	VCE(sat)2		2.0	V dc
Forward-current transfer ratio	! !	$V_{CE} = 3 \text{ V dc};$ $I_C = 1 \text{ A dc};$ pulsed (see 4.5.1)	h _{FE1}	1,000		
Forward-current transfer ratio		V _{CE} = 3 V dc; I _C = 6 A dc; pulsed (see 4.5.1)	h _{FE2}	1,000	18,000	

See footnote at end of table.

TABLE I. Group A inspection - Continued.

	MIL-STD-750		Combal	Limit		l Unit
Inspection 1/	Method Conditions		Symbol	Min	Max	- Unit
Subgroup 2 - Continued Forward-current transfer ratio	3076		 	150		;
Subgroup 3					ĺ	į
High-temperature operation:	1	 T _A = +150°C 		1		
Collector - emitter cutoff current 2N6051 2N6052	3041	 Bies condition A; V _{BE} = 1.5 V dc; V _{CE} = 80 V dc V _{CE} = 100 V dc	I _{CEX2}		5.0	mA dc
<pre>Collector - emitter voltage (saturated)</pre>		 I _C = 6 A dc; I _B = 24 mA dc; putsed (see 4.5.1)	V _{CE(sat)}		2.0	V dc
Low-temperature operation:	 	T _A = -55°C				
Forward-current transfer ratio		 V _{CE} = 3 V dc; I _C = 6 A dc; pulsed (see 4.5.1)	h _{FE4}	300		† †
Subgroup 4	1 [
Small-signal short- circuit forward- current transfer ratio		V _{CE} = 3 V dc; I _C = 5 A dc; f = 1 kHz	h _{fe}	1,000		
Magnitude of common- emitter small-signal short-circuit forward- current transfer ratio		V _{CE} = 3 V dc; I _C = 5 A dc; f = 1.0 MHz	h _{fe}	10	250	
Open circuit output capacitance		V _{CB} = 10 V dc; I _E = 0; 100 kHz ≤ f ≤ 1 MHz	Соро		300	† pF
Pulse response Turn-on time		(See figure 3); $V_{CC} = 30 \text{ V dc}$; $I_C = 5 \text{ A dc}$; $I_B = 20 \text{ mA dc}$	ton		2.0	 µs
Turn-off time	İ	(See figure 4); V _{CC} = 30 V dc; I _C = 5 A dc; I _{B1} = I _{B2} = 20 mA dc	toff		 10 	μs

See footnote at end of table.

TABLE I. Group A inspection - Continued.

MIL-STD-750			1	1	Limit	
Inspection 1/				 		Unit
 	Method	Conditions	i 	Min	Max	1
 Subgroup 5	1		1	1	1	;
Safe operating area (dc)	3051	 T _C = +25°C +10°C -0°C; t ≥ 1 s; 1 cycle; (see figure 3)				
Test 1		 V _{CE} = 12.5 V dc; I _C = 12 A dc			1	
Test 2		 V _{CE} = 30 V dc; I _C = 5 A dc		1	 	
Test 3				!	!	
2 N6 051		 V _{CE} = 70 V dc; I _C = 200 mA dc			! !	
2n6052		 V _{CE} = 90 V dc; I _C = 155 mA dc			1 1 1	
Safe operating area (switching)		Load condition B; (clamped inductive load); $T_A = +25^{\circ}C$; $t_r + t_f \le 1.0 \ \mu s$; duty cycle ≤ 2 percent; $t_p = 1 \ ms$; (vary to obtain I_C); $R_s = 0.10 \ \Omega$; $R_{BB1} = 80 \ \Omega$; $V_{BB1} = 16 \ V \ dc$; $R_{BB2} = 100 \ \Omega$; $V_{BB2} = 1.5 \ V \ dc$; $I_C = 12 \ A \ dc$; $V_{CC} = 20 \ V \ dc$; $R_L \le 2 \ \Omega$; $L = 10 \ mH$; (Stancor $C = 2688 \ or$ equivalent)				
2N6O51		clamp voltage = 80 +0, -5 V dc	 			!
2N6O52		clamp voltagn = 100 +0, -5 V dc Device fails if clamp voltage not reached	 			
Endpoint electrical measurements		See table II, steps 1 and 5				
Subgroups 6 and 7	ł					
Not applicable	! !			<u> </u>		1

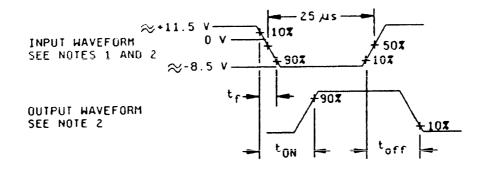
 $[\]underline{1}/$ For sampling plan, see MIL-S-19500.

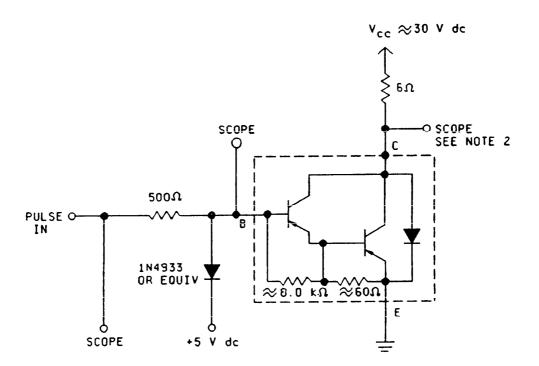
MIL-S-1900/5018

TABLE II. Groups A, B, and C electrical measurements. 1/2/

		MIL-STD-750		6	Li	Unit		
Step	Inspection	Method	Conditions	Symbol	Min	Max	Unit	
1.	Collector - emitter cutoff current 2N6051 2N6052	3041	Bias condition A; V _{BE} = 1.5 V dc; V _{CE} = 80 V dc V _{CE} = 100 V dc	I _{CEX1}		0.5	, mA dc	
2.	Collector - emitter cutoff current 2N6051 2N6052	3041	Bias condition A; VBE = 1.5 V dc; VCE = 80 V dc VCE = 100 V dc	I CEX1		1.0	mA dc	
3.	Forward-current transfer ratio	3076	V _{CE} = 3 V dc; I _C = 6 A dc; pulsed (see 4.5.1)	h _{FE2}	1,000	18,000		
4.	Forward-current transfer ratio	3076	V _{CE} = 3 V dc; I _C = 6 A dc; pulsed (see 4.5.1)	Ah _{FE2}	±40 percent			

- $\underline{1}$ / The electrical measurements for table IVb (JAN, JANTX and JANTXV) of MIL-S-19500 are as follows:
 - a. Subgroup 2, see table II herein, steps 1 and 3.
 - b. Subgroups 3 and 6, see table II herein, steps 2 and 4.
- $\underline{2}/$ The electrical measurements for table V of MIL-S-19500 are as follows:
 - a. Subgroup 3, see table II herein, steps 1 and 3.
 - b. Subgroup 6, see table II herein, steps 2 and 4.





NOTES:

- 1. The input waveform is supplied by a pulse generator with the following characteristics: $t_r \le 20$ ns, $t_f \le 20$ ns, $t_{out} = 50 \,\Omega$, PW = 25 μ s, duty cycle ≤ 2 percent.
- 2. Output wave forms are monitored on an oscilloscope with the following characteristics: $t_r \le 2.0 \text{ ns}, \ Z_{in} \ge 20 \text{ k}\Omega, \ C_{in} \le 11.5 \text{ pf}.$ 3. Resistors shall be noninductive types.
- 4. The dc power supplies may require additional by-passing in order to minimize ringing.

FIGURE 2. Pulse response test circuit.

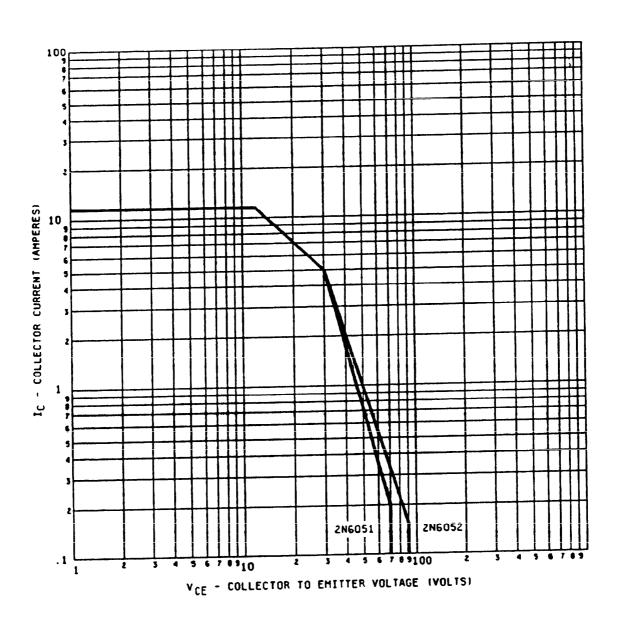


FIGURE 3. Maximum safe operating area graph (continuous dc).

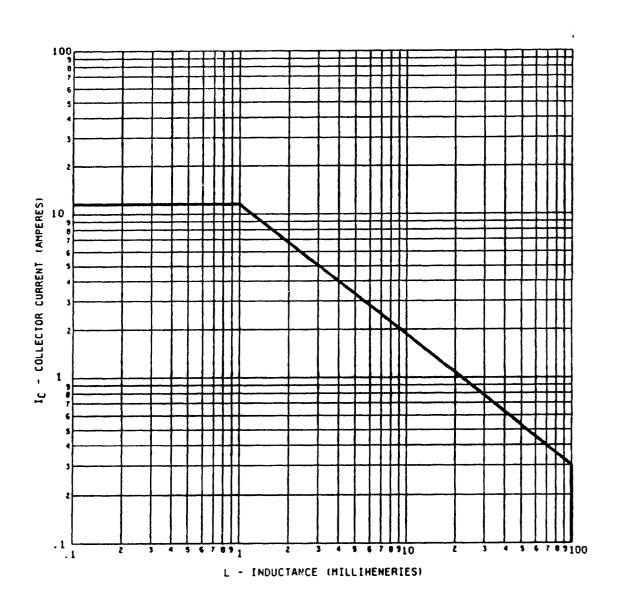


FIGURE 4. Safe operating area for switching between saturation and cutoff (unclamped inductive load).

- 4.5 <u>flethod of inspection</u>. Methods of inspection shall be as specified in the appropriate tables and as follows.
- 4.5.1 <u>Pulse measurements</u>. Conditions for pulse measurement shall be as specified in section 4 of MIL-STD-750.
 - 5. PACKAGING
 - 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-S-19500.
 - 6 NOTES

(This section contains information of a general or explanatory nature that may be helpful, but is not mandatory.)

- 6.1 Notes. The notes specified in MIL-S-19500 are applicable to this specification.
- 6.2 Acquisition requirements. Acquisition documents should specify the following:
 - a. Issue of DODISS to be cited in the solicitation.
 - b. Lead finish as specified (see 3.3.1).
 - c. Type designation and product assurance level.
- 6.3 <u>Changes from previous issue</u>. Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extensiveness of the changes.

CONCLUDING MATERIAL

Custodians: Army - ER

Navy - EC Air Force - 17

NASA - NA

Review activities:

Air Force - 13, 15, 19, 85, 99

Preparing activity:

DLA - ES

Agent:

DLA - ES

(Project 5961-1744)

STANDARDIZATION DOCUMENT IMPROVEMENT PROPOSAL

INSTRUCTIONS

- 1. The preparing activity must complete blocks 1, 2, 3, and 8. In block 1, both the document number and revision letter should be given.
- 2. The submitter of this form must complete blocks 4, 5, 6, and 7.
- 3. The preparing activity must provide a reply within 30 days from receipt of the form.

NOTE: This form may not be used to request copies of documents, nor to request waivers, or clarification of requirements on current contracts. Comments submitted on this form do not constitute or imply authorization to waive any portion of the referenced document(s) or to amend contractual requirements.

I RECOMMEND A CHANGE:

1. DOCUMENT NUMBER MIL-S-19500/501B

- 2. DOCUMENT DATE (YYPRIDD) 950325
- 3. DOCUMENT TITLE SEMICONDUCTOR DEVICE, DARLINGTON TRANSISTOR, PNP, SILICON, POWER, TYPE 2N6051, 2N6052 JAN, JANTX AND JANTXV
- 4. NATURE OF CHANGE (Identify paragraph number and include proposed rewrite, if possible. Attach extra sheets as needed.)

5. REASON FOR RECOMMENDATION

6. SIEMLITTER		
#. NAME (Last, First, Middle initial)	b. ORGANIZATION	*************
6. ADDRESS (Include Zip Code)	d. TELEPHONE (Include Area Code)	7. DATE SUBMITTED
	(1) commercial (2) AUTOVON (1f applicable)	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
8. PREPARING ACTIVITY		

b. TELEPHONE (Include Area Code) a. NAME (1) Commercial (2) AUTOVON

والمناف المنافية والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة والمنافرة

c. ADDRESS (Include Zip Code) IF YOU DO NOT RECEIVE A REPLY WITHIN 45 DAYS, CONTACT: Defense Quality and Standardization Office 5203 Leesburg Pike, Suite 1403, Falls Church, VA 22041-3466 Telephone (703) 756-2340 AUTOVON 289-2340

DD Form 1426, OCT 89

Previous editions are obsolete

198/290